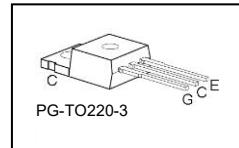
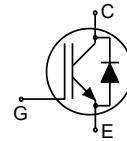


Low Loss DuoPack : IGBT in TRENCHSTOP™ and Fieldstop technology with soft, fast recovery anti-parallel Emitter Controlled HE diode


Features:

- Very low $V_{CE(sat)}$ 1.5V (typ.)
- Maximum Junction Temperature 175°C
- Short circuit withstand time 5μs
- Designed for :
 - Frequency Converters
 - Uninterrupted Power Supply
- TRENCHSTOP™ and Fieldstop technology for 600V applications offers :
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - very high switching speed
 - low $V_{CE(sat)}$
- Positive temperature coefficient in $V_{CE(sat)}$
- Low EMI
- Low Gate Charge
- Very soft, fast recovery anti-parallel Emitter Controlled HE diode
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>



Type	V_{CE}	I_C	$V_{CE(sat)}, T_j=25^\circ C$	$T_{j,max}$	Marking	Package
IKP20N60T	600V	20A	1.5V	175°C	K20T60	PG-T0220-3

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_j \geq 25^\circ C$	V_{CE}	600	V
DC collector current, limited by $T_{j,max}$	I_C	41	
$T_C = 25^\circ C$		28	
$T_C = 100^\circ C$			
Pulsed collector current, t_p limited by $T_{j,max}$	$I_{C,puls}$	60	A
Turn off safe operating area, $V_{CE} = 600V$, $T_j = 175^\circ C$, $t_p = 1\mu s$	-	60	
Diode forward current, limited by $T_{j,max}$	I_F	41	
$T_C = 25^\circ C$		28	
$T_C = 100^\circ C$			
Diode pulsed current, t_p limited by $T_{j,max}$	$I_{F,puls}$	60	
Gate-emitter voltage	V_{GE}	± 20	V
Short circuit withstand time ²⁾	t_{sc}	5	μs
$V_{GE} = 15V$, $V_{CC} \leq 400V$, $T_j \leq 150^\circ C$			
Power dissipation $T_C = 25^\circ C$	P_{tot}	166	W
Operating junction temperature	T_j	-40...+175	
Storage temperature	T_{stg}	-55...+150	$^\circ C$
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260	

¹ J-STD-020 and JESD-022

²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.

Thermal Resistance

Parameter	Symbol	Conditions	Max. Value		Unit
Characteristic					
IGBT thermal resistance, junction – case	R_{thJC}		0.9		K/W
Diode thermal resistance, junction – case	R_{thJCD}		1.5		
Thermal resistance, junction – ambient	R_{thJA}		62		

Electrical Characteristic, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0\text{V}, I_C=0.2\text{mA}$	600	-	-	
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$	$V_{GE} = 15\text{V}, I_C=20\text{A}$	-	1.5	2.05	V
		$T_j=25^\circ\text{C}$	-	1.9	-	
Diode forward voltage	V_F	$V_{GE}=0\text{V}, I_F=20\text{A}$	-	1.65	2.05	
		$T_j=25^\circ\text{C}$	-	1.6	-	
Gate-emitter threshold voltage	$V_{GE(\text{th})}$	$I_C=290\mu\text{A}, V_{CE}=V_{GE}$	4.1	4.9	5.7	
Zero gate voltage collector current	I_{CES}	$V_{CE}=600\text{V}, V_{GE}=0\text{V}$	-	-	40	μA
		$T_j=25^\circ\text{C}$	-		1500	
Gate-emitter leakage current	I_{GES}	$V_{CE}=0\text{V}, V_{GE}=20\text{V}$	-	-	100	nA
Transconductance	g_{fs}	$V_{CE}=20\text{V}, I_C=20\text{A}$	-	11	-	S
Integrated gate resistor	R_{Gint}			-		Ω

Dynamic Characteristic

Input capacitance	C_{iss}	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$	-	1100	-	pF
Output capacitance	C_{oss}		-	71	-	
Reverse transfer capacitance	C_{rss}		-	32	-	
Gate charge	Q_{Gate}	$V_{CC}=480\text{V}, I_C=20\text{A}, V_{GE}=15\text{V}$	-	120	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	L_E	PG-T0220-3	-	7	-	nH
Short circuit collector current ¹⁾	$I_{C(\text{SC})}$	$V_{GE}=15\text{V}, t_{sc}\leq 5\mu\text{s}$ $V_{CC} = 400\text{V}, T_j \leq 150^\circ\text{C}$	-	183.3	-	A

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.

Switching Characteristic, Inductive Load, at $T_j=25\text{ }^\circ\text{C}$

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	$T_j=25\text{ }^\circ\text{C}$, $V_{CC}=400\text{V}$, $I_C=20\text{A}$, $V_{GE}=0/15\text{V}$, $r_G=12\Omega$, $L_\sigma=131\text{nH}$, $C_\sigma=31\text{pF}$	-	18	-	ns
Rise time	t_r		-	14	-	
Turn-off delay time	$t_{d(off)}$		-	199	-	
Fall time	t_f		-	42	-	
Turn-on energy	E_{on}	L_σ , C_σ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	0.31	-	mJ
Turn-off energy	E_{off}		-	0.46	-	
Total switching energy	E_{ts}		-	0.77	-	

Anti-Parallel Diode Characteristic

Diode reverse recovery time	t_{rr}	$T_j=25\text{ }^\circ\text{C}$,	-	41	-	ns
Diode reverse recovery charge	Q_{rr}	$V_R=400\text{V}$, $I_F=20\text{A}$,	-	0.31	-	μC
Diode peak reverse recovery current	I_{rrm}	$di_F/dt=880\text{A}/\mu\text{s}$	-	13.3	-	A
Diode peak rate of fall of reverse recovery current during t_b	di_{rr}/dt		-	711	-	$\text{A}/\mu\text{s}$

Switching Characteristic, Inductive Load, at $T_j=175\text{ }^\circ\text{C}$

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	$T_j=175\text{ }^\circ\text{C}$, $V_{CC}=400\text{V}$, $I_C=20\text{A}$, $V_{GE}=0/15\text{V}$, $r_G=12\Omega$, $L_\sigma=131\text{nH}$, $C_\sigma=31\text{pF}$	-	18	-	ns
Rise time	t_r		-	18	-	
Turn-off delay time	$t_{d(off)}$		-	223	-	
Fall time	t_f		-	76	-	
Turn-on energy	E_{on}	L_σ , C_σ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	0.51	-	mJ
Turn-off energy	E_{off}		-	0.64	-	
Total switching energy	E_{ts}		-	1.15	-	

Anti-Parallel Diode Characteristic

Diode reverse recovery time	t_{rr}	$T_j=175\text{ }^\circ\text{C}$	-	176	-	ns
Diode reverse recovery charge	Q_{rr}	$V_R=400\text{V}$, $I_F=20\text{A}$,	-	1.46	-	μC
Diode peak reverse recovery current	I_{rrm}	$di_F/dt=880\text{A}/\mu\text{s}$	-	18.9	-	A
Diode peak rate of fall of reverse recovery current during t_b	di_{rr}/dt		-	467	-	$\text{A}/\mu\text{s}$

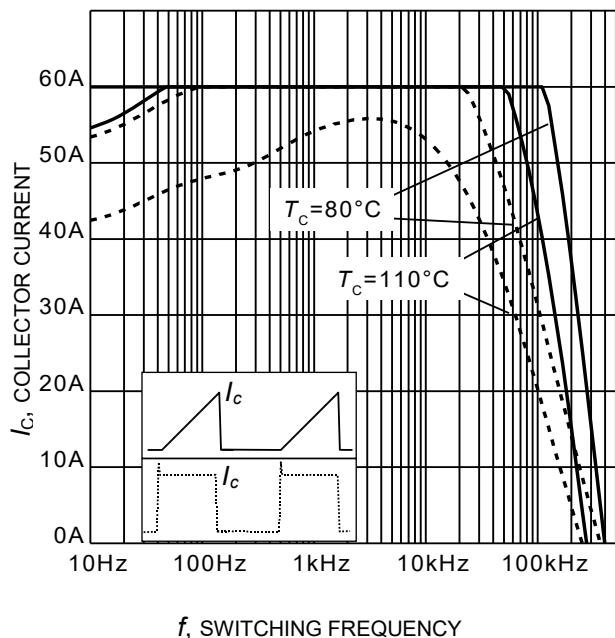


Figure 1. Collector current as a function of switching frequency
 $(T_j \leq 175^\circ\text{C}, D = 0.5, V_{CE} = 400\text{V}, V_{GE} = 0/15\text{V}, r_G = 12\Omega)$

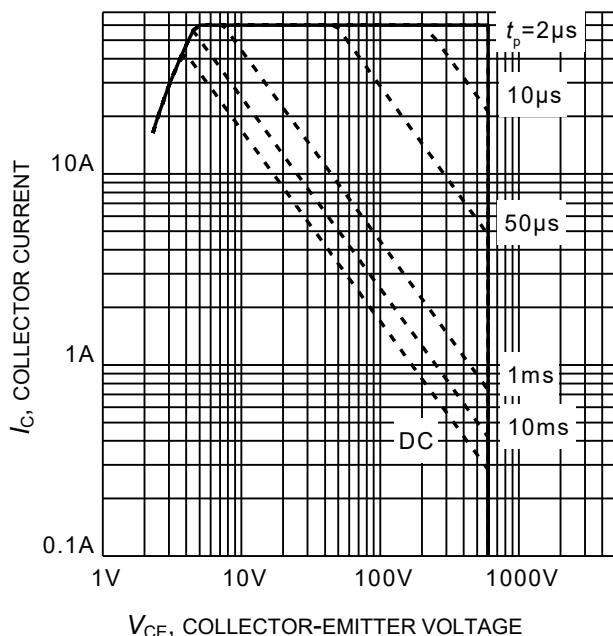


Figure 2. Safe operating area
 $(D = 0, T_C = 25^\circ\text{C}, T_j \leq 175^\circ\text{C}, V_{GE}=0/15\text{V})$

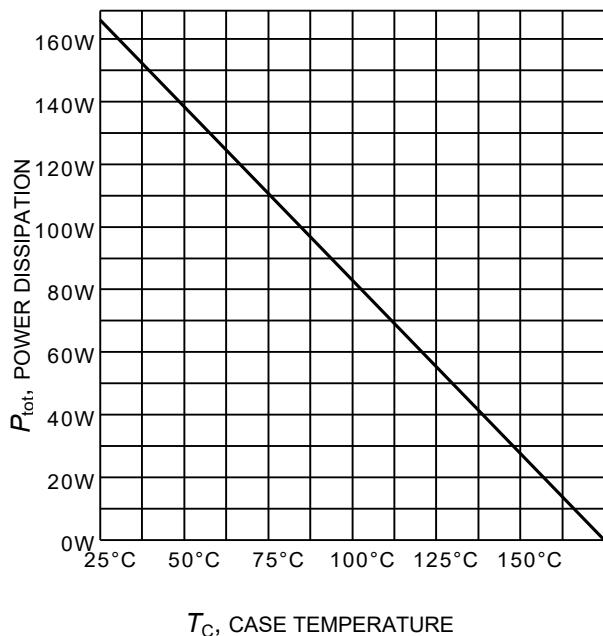


Figure 3. Power dissipation as a function of case temperature
 $(T_j \leq 175^\circ\text{C})$

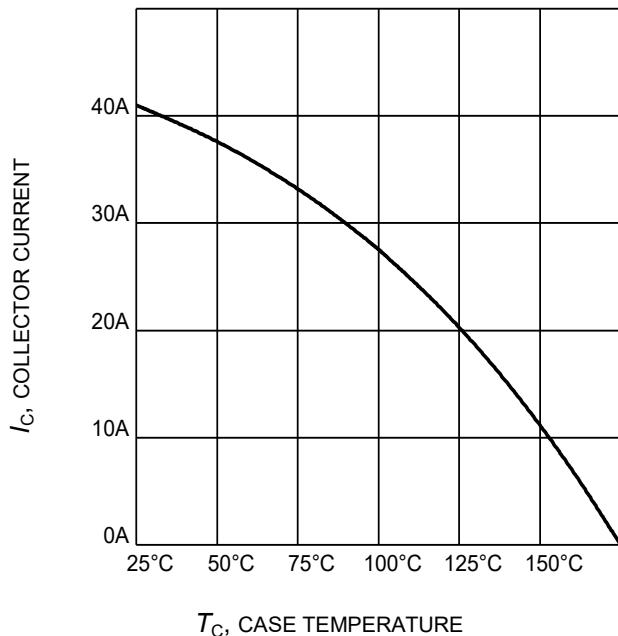


Figure 4. Collector current as a function of case temperature
 $(V_{GE} \geq 15\text{V}, T_j \leq 175^\circ\text{C})$

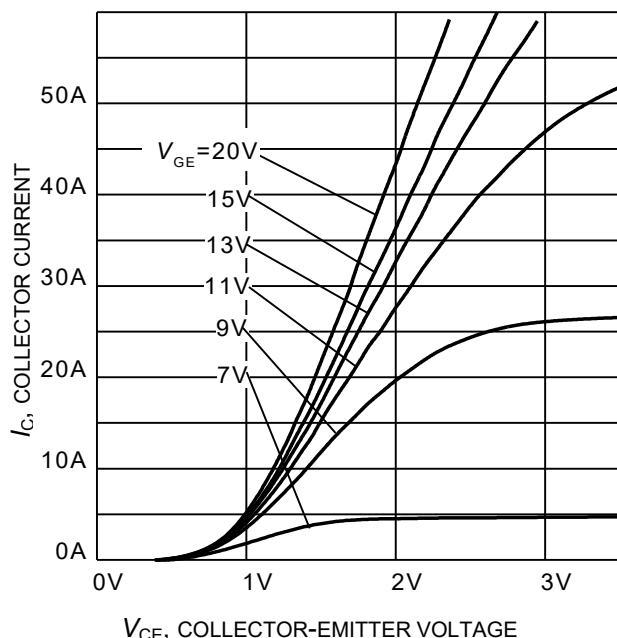


Figure 5. Typical output characteristic
($T_j = 25^\circ\text{C}$)

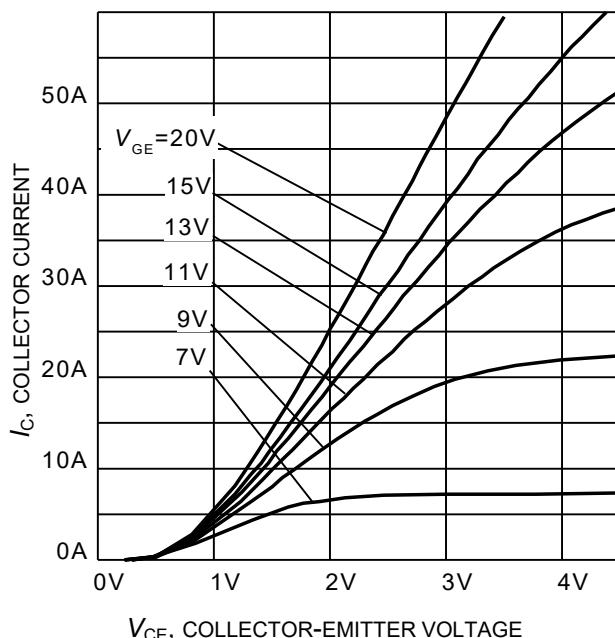


Figure 6. Typical output characteristic
($T_j = 175^\circ\text{C}$)

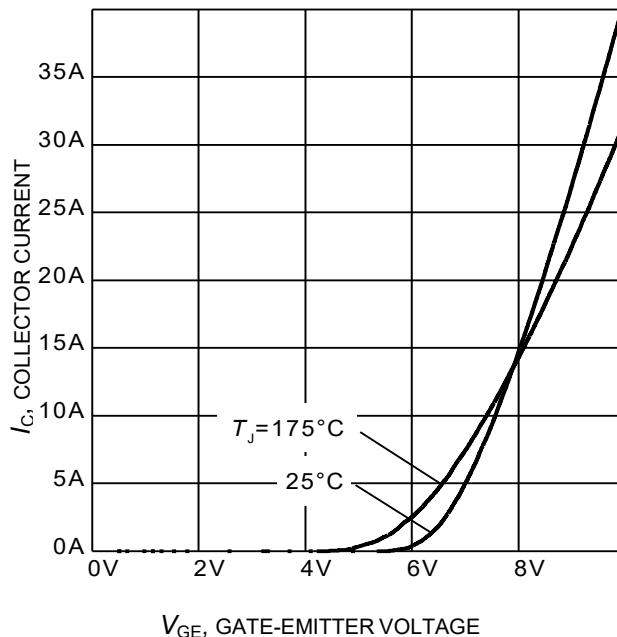


Figure 7. Typical transfer characteristic
($V_{CE} = 10\text{V}$)

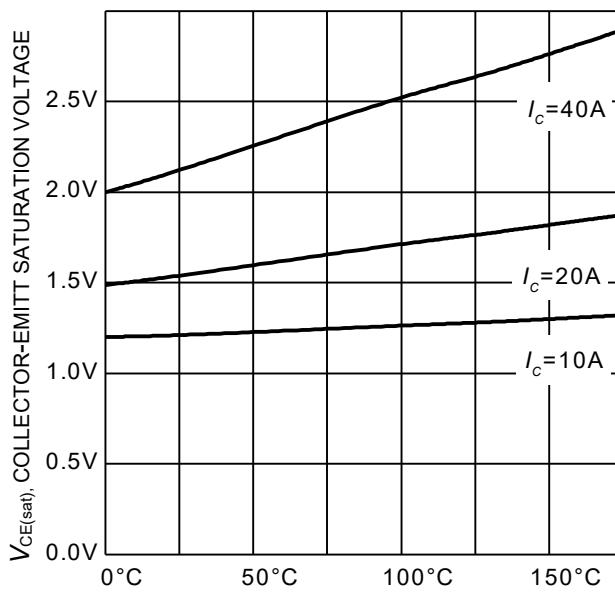


Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature
($V_{GE} = 15\text{V}$)

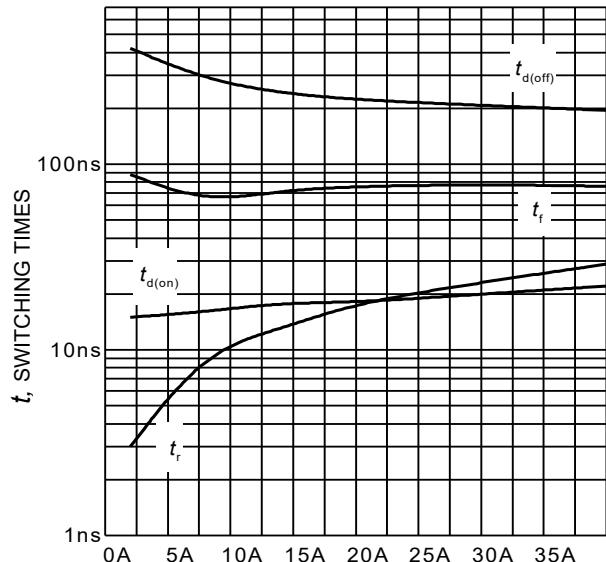

I_C, COLLECTOR CURRENT

Figure 9. Typical switching times as a function of collector current
(inductive load, $T_J=175^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $V_{GE}=0/15\text{V}$, $r_G=12\Omega$, Dynamic test circuit in Figure E)

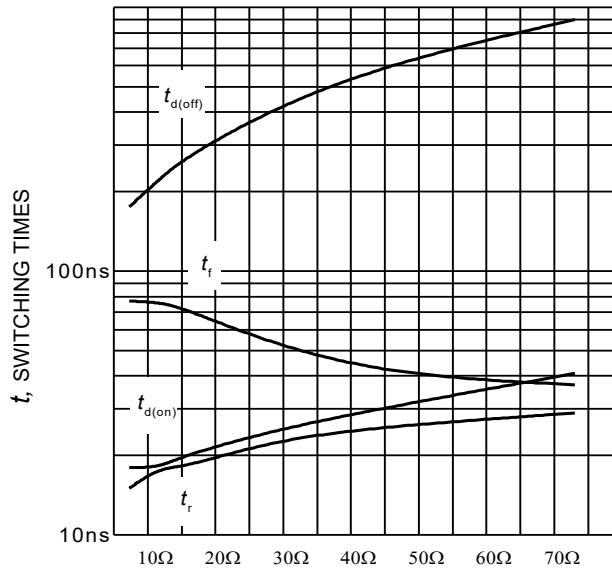

R_G, GATE RESISTOR

Figure 10. Typical switching times as a function of gate resistor
(inductive load, $T_J=175^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $V_{GE}=0/15\text{V}$, $I_C=20\text{A}$, Dynamic test circuit in Figure E)

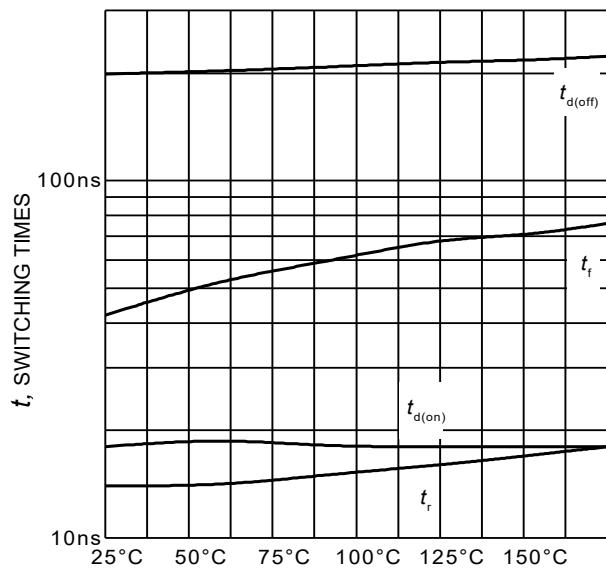

T_J, JUNCTION TEMPERATURE

Figure 11. Typical switching times as a function of junction temperature
(inductive load, $V_{CE}=400\text{V}$, $V_{GE}=0/15\text{V}$, $I_C=20\text{A}$, $r_G=12\Omega$, Dynamic test circuit in Figure E)

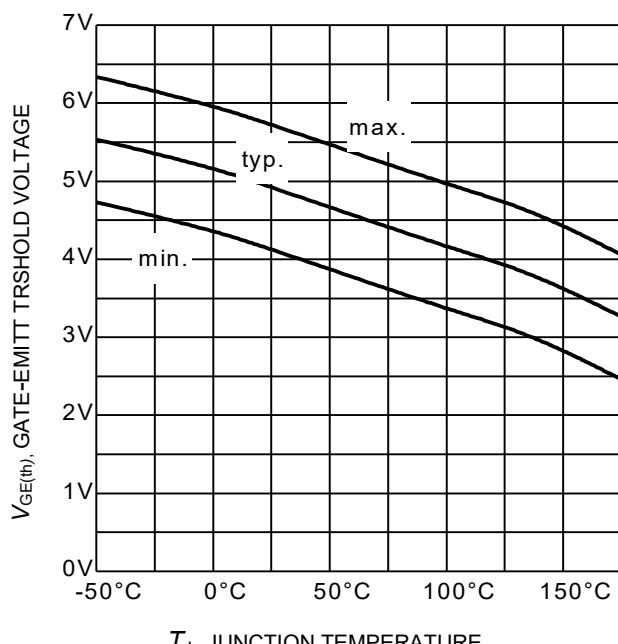

T_J, JUNCTION TEMPERATURE

Figure 12. Gate-emitter threshold voltage as a function of junction temperature
($I_C=0.29\text{mA}$)

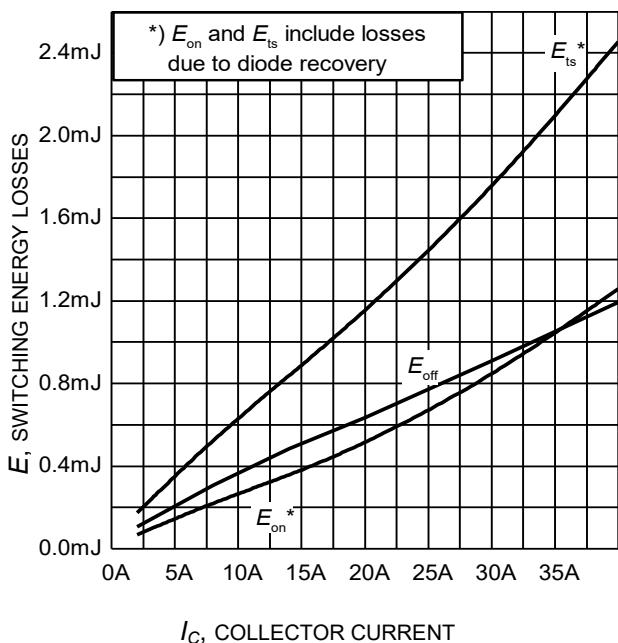


Figure 13. Typical switching energy losses as a function of collector current
(inductive load, $T_J = 175^\circ\text{C}$,
 $V_{CE} = 400\text{V}$, $V_{GE} = 0/15\text{V}$, $r_G = 12\Omega$,
Dynamic test circuit in Figure E)

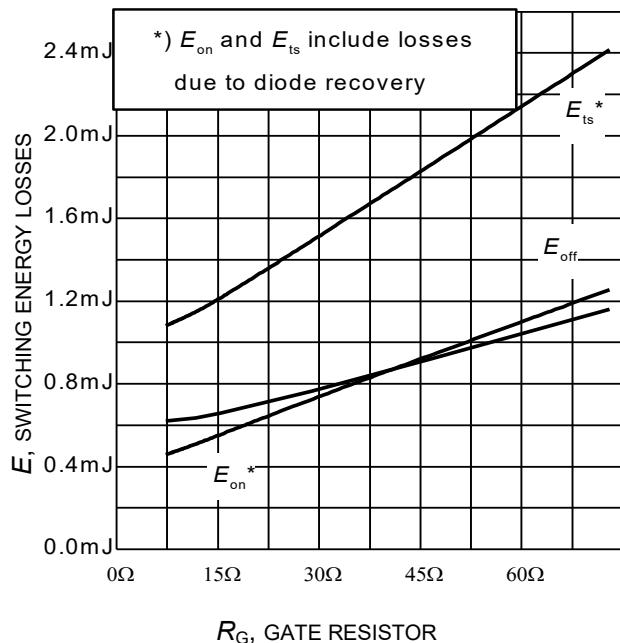


Figure 14. Typical switching energy losses as a function of gate resistor
(inductive load, $T_J = 175^\circ\text{C}$,
 $V_{CE} = 400\text{V}$, $V_{GE} = 0/15\text{V}$, $I_C = 20\text{A}$,
Dynamic test circuit in Figure E)

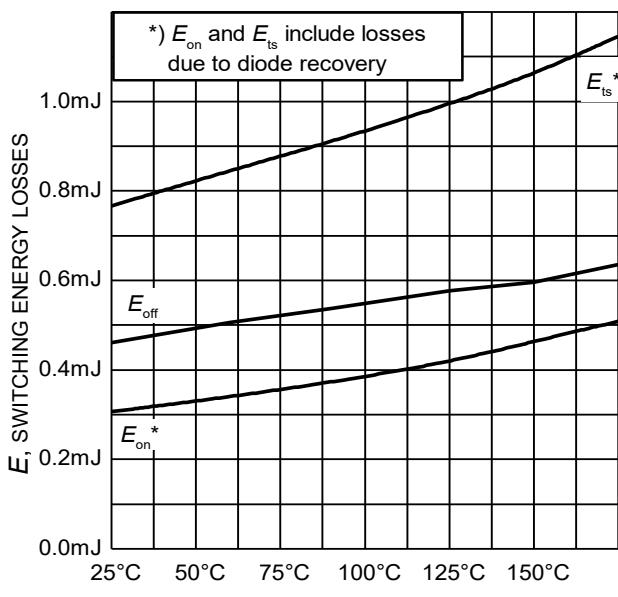


Figure 15. Typical switching energy losses as a function of junction temperature
(inductive load, $V_{CE} = 400\text{V}$,
 $V_{GE} = 0/15\text{V}$, $I_C = 20\text{A}$, $r_G = 12\Omega$,
Dynamic test circuit in Figure E)

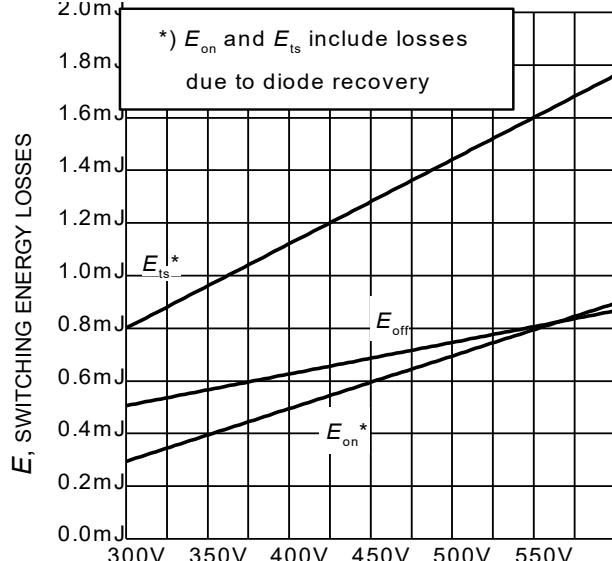


Figure 16. Typical switching energy losses as a function of collector emitter voltage
(inductive load, $T_J = 175^\circ\text{C}$,
 $V_{GE} = 0/15\text{V}$, $I_C = 20\text{A}$, $r_G = 12\Omega$,
Dynamic test circuit in Figure E)

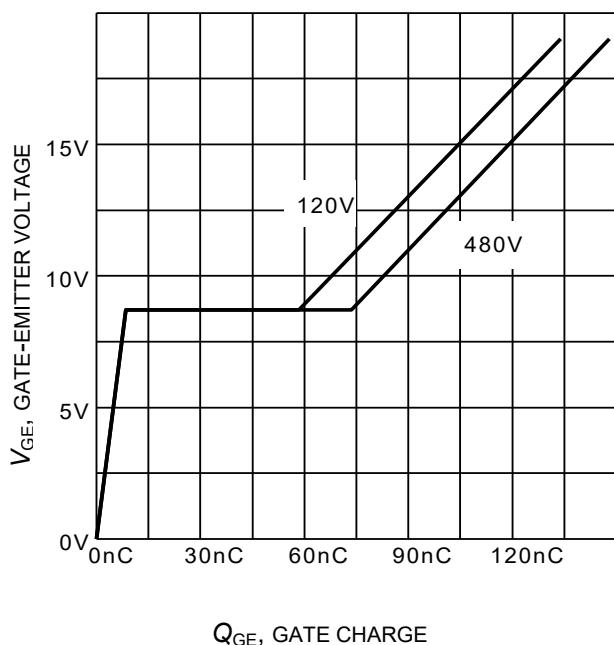


Figure 17. Typical gate charge
($I_C=20$ A)

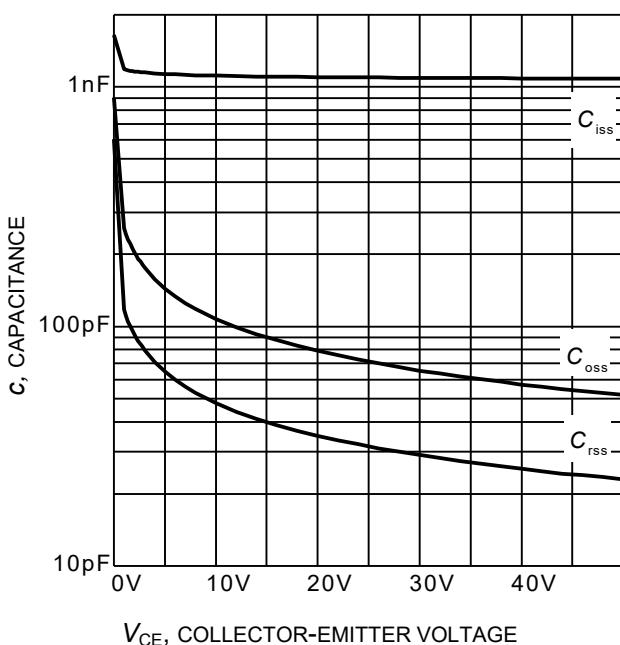


Figure 18. Typical capacitance as a function of collector-emitter voltage
($V_{GE}=0$ V, $f = 1$ MHz)

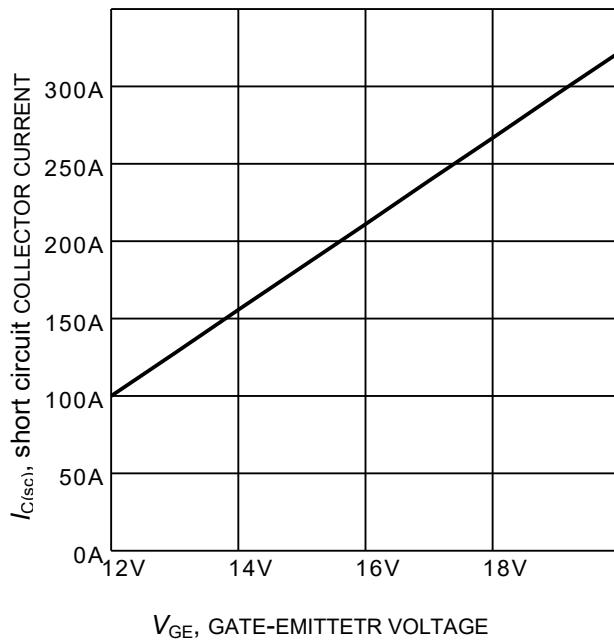


Figure 19. Typical short circuit collector current as a function of gate-emitter voltage
($V_{CE} \leq 400$ V, $T_j \leq 150^\circ\text{C}$)

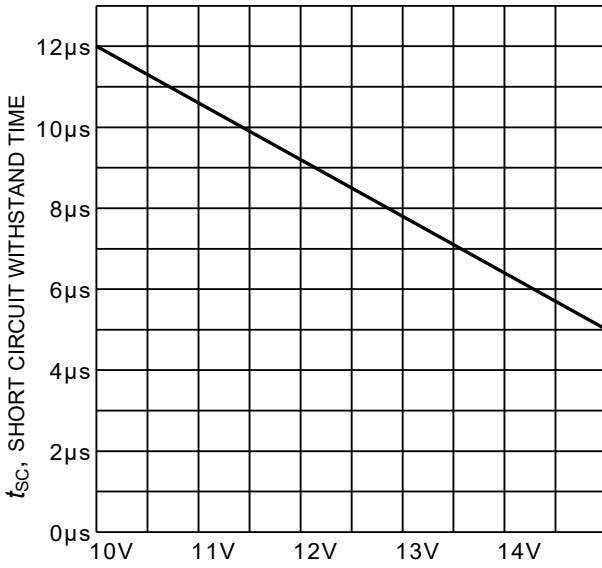


Figure 20. Short circuit withstand time as a function of gate-emitter voltage
($V_{CE}=400$ V, start at $T_j=25^\circ\text{C}$,
 $T_{jmax}<150^\circ\text{C}$)

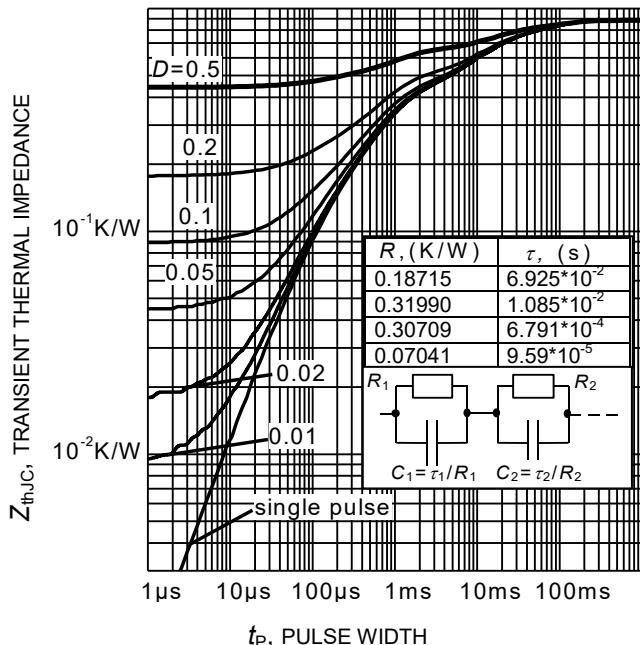


Figure 21. IGBT transient thermal impedance
($D = t_p / T$)

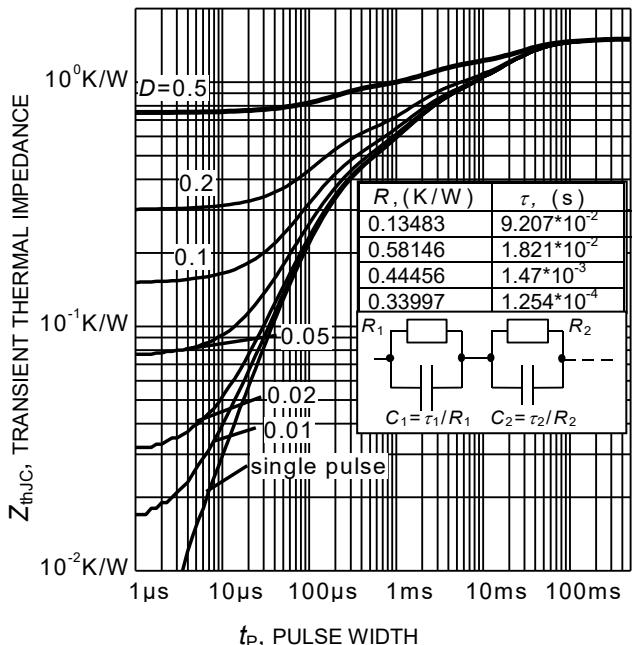


Figure 22. Diode transient thermal impedance as a function of pulse width
($D=t_p/T$)

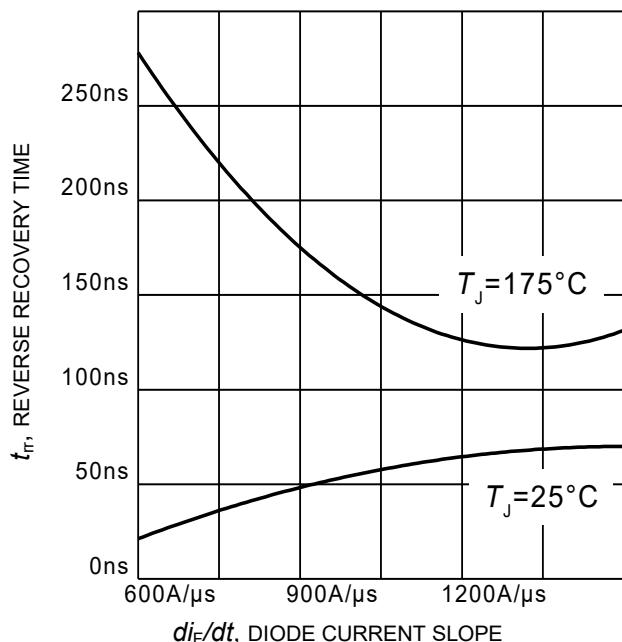


Figure 23. Typical reverse recovery time as a function of diode current slope
($V_R=400\text{V}$, $I_F=20\text{A}$, Dynamic test circuit in Figure E)

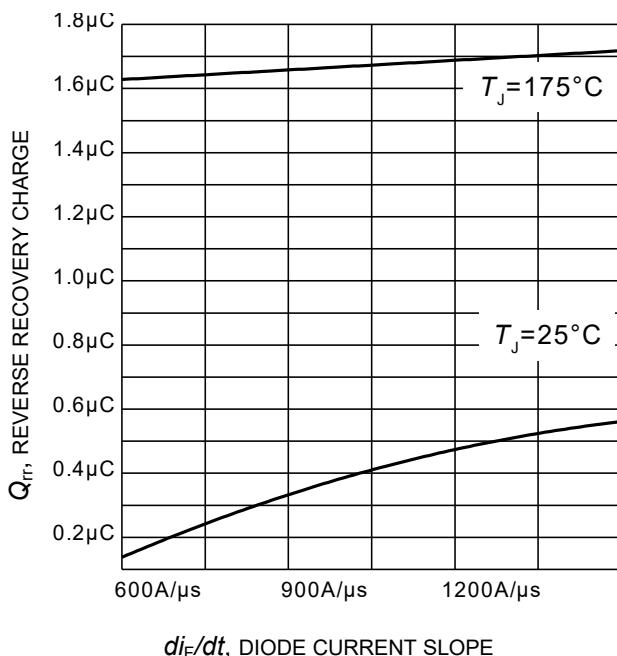
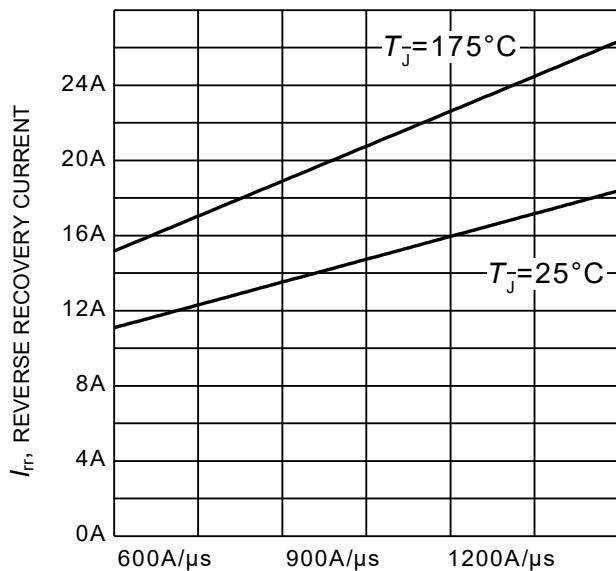


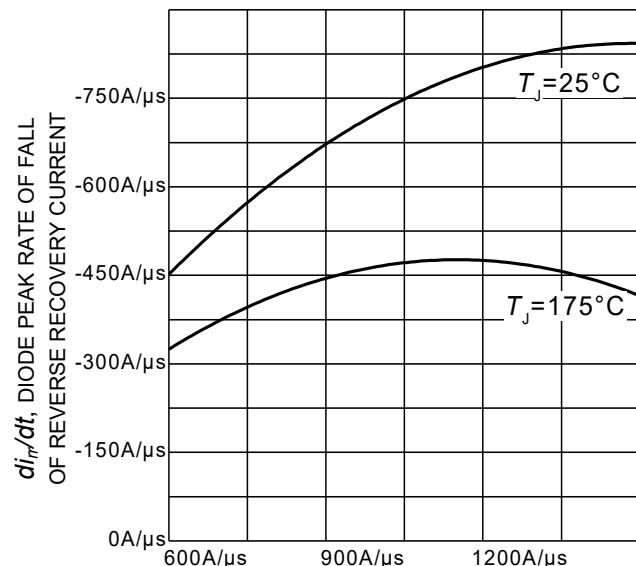
Figure 24. Typical reverse recovery charge as a function of diode current slope
($V_R = 400\text{V}$, $I_F = 20\text{A}$, Dynamic test circuit in Figure E)



di_F/dt , DIODE CURRENT SLOPE

Figure 25. Typical reverse recovery current as a function of diode current slope

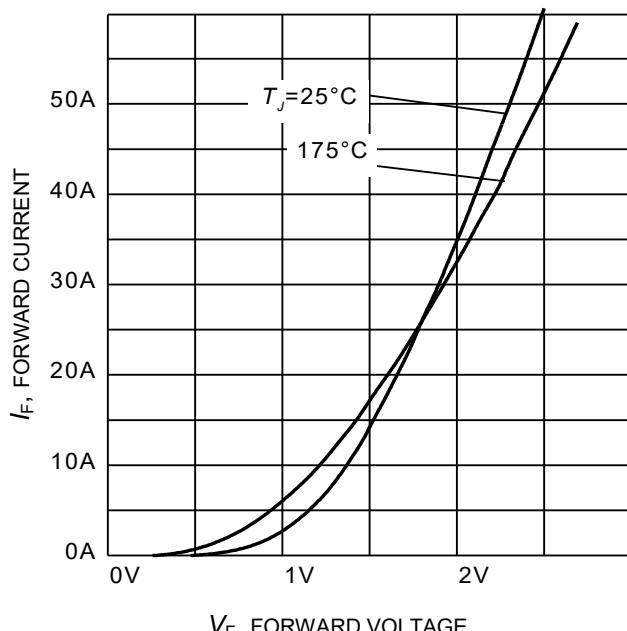
($V_R = 400V$, $I_F = 20A$,
Dynamic test circuit in Figure E)



di_F/dt , DIODE CURRENT SLOPE

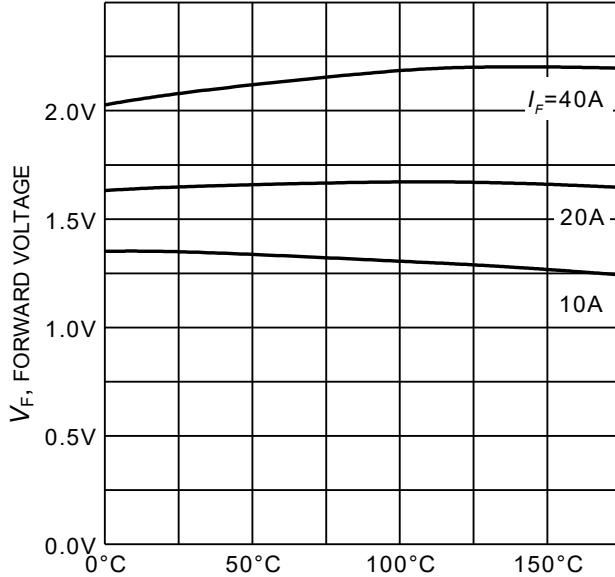
Figure 26. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope

($V_R=400V$, $I_F=20A$,
Dynamic test circuit in Figure E)



V_F , FORWARD VOLTAGE

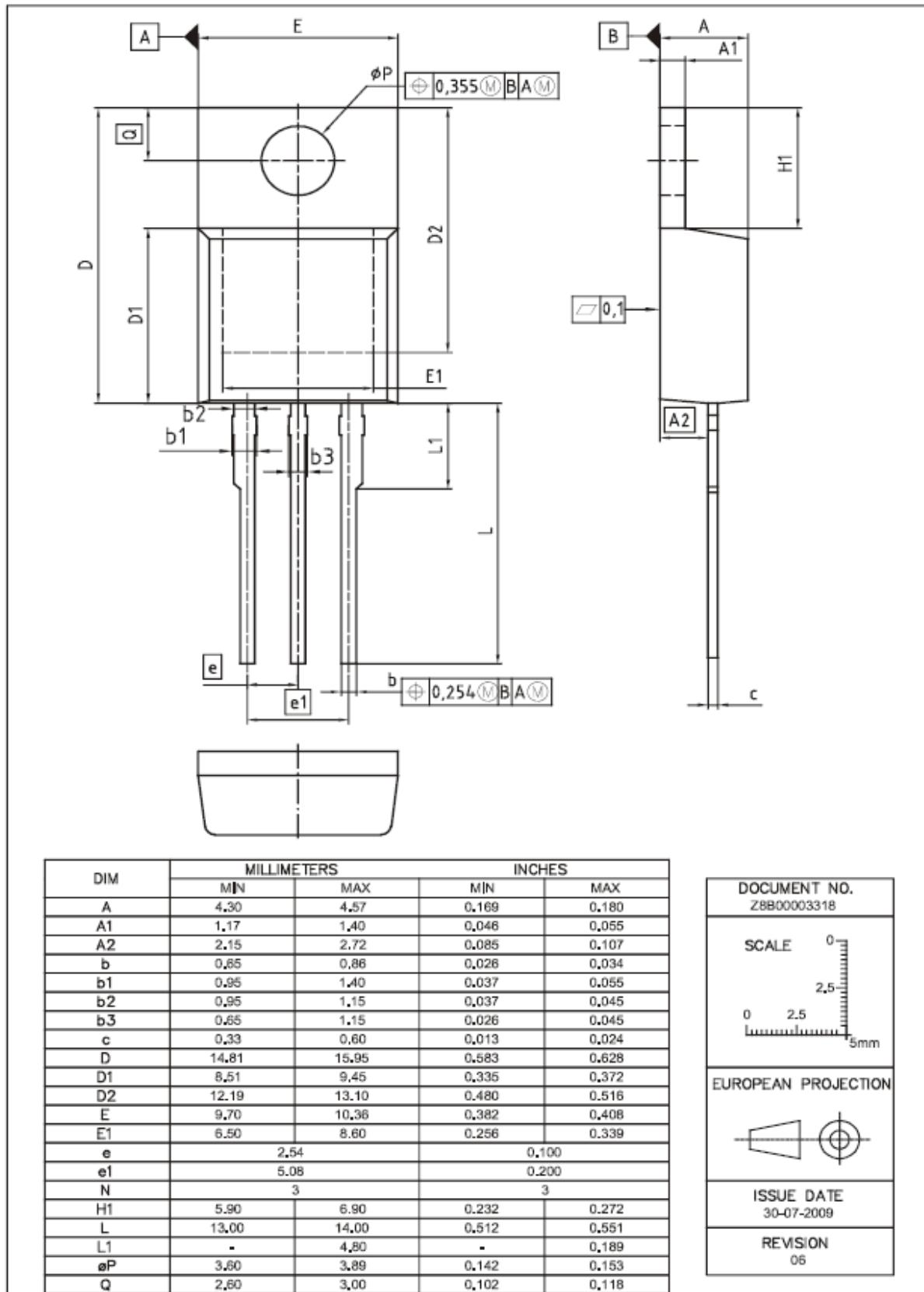
Figure 27. Typical diode forward current as a function of forward voltage

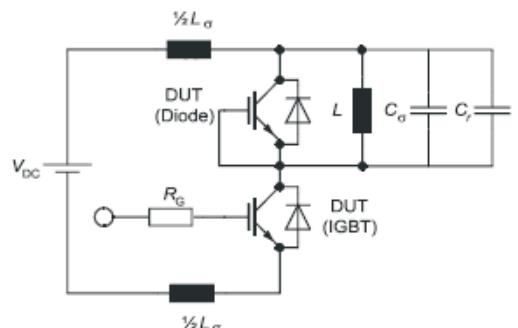
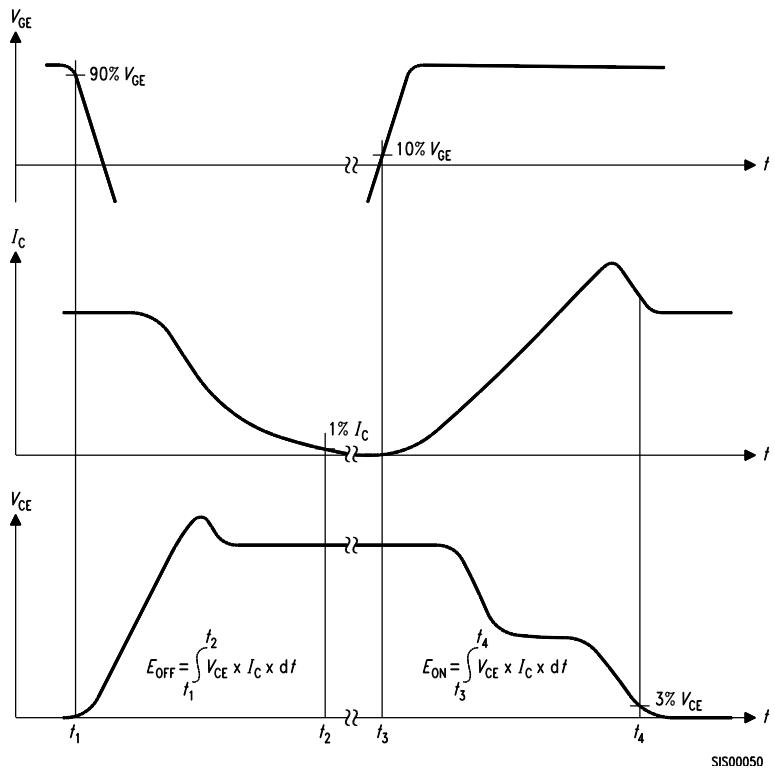
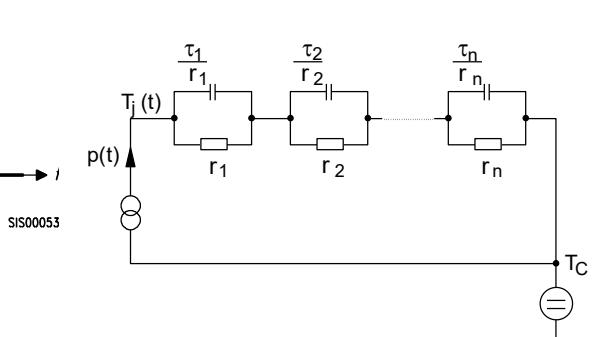
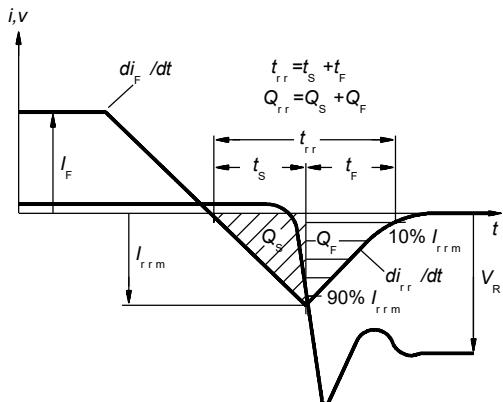
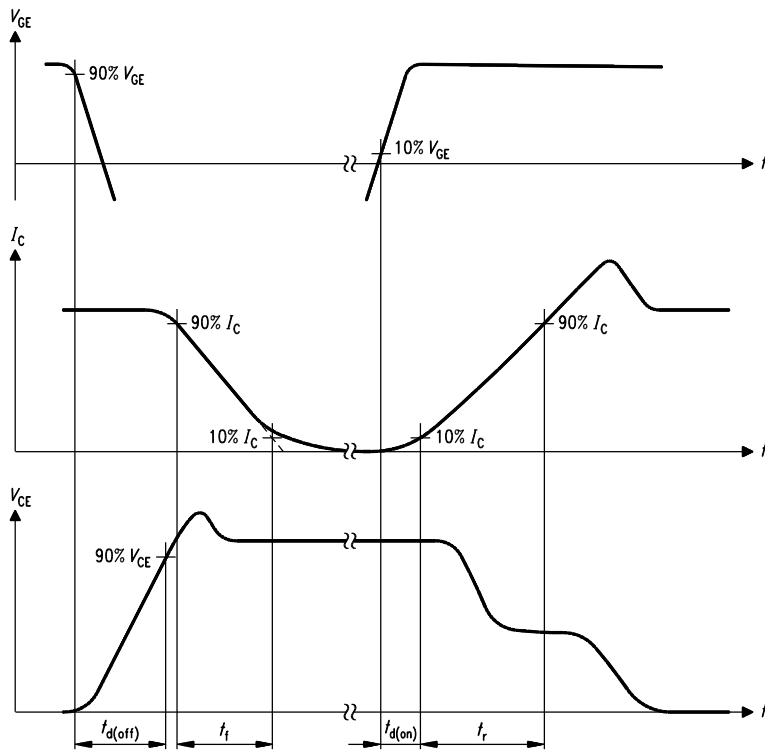


T_J , JUNCTION TEMPERATURE

Figure 28. Typical diode forward voltage as a function of junction temperature

PG-T0220-3





Parasitic inductance L_α ,
Parasitic capacitor C_α ,
Relief capacitor C_r ,
(only for ZVT switching)



IKP20N60T

TRENCHSTOP™ Series

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